

11/5/05

ELECTRONIC INFORMATION DISCLOSURE STATEMENT

Electronic Version v18

Stylesheet Version v18.0

Title of Invention

A SUSPENSION FOR FILLING VIA HOLES IN SILICON AND
METHOD FOR MAKING THE SAME

Application Number :

10/707,693

Confirmation Number:

First Named Applicant:

JON CASEY

Attorney Docket Number:

FIS920030334US1

Art Unit:

2823

Examiner:


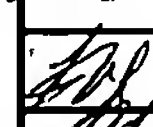

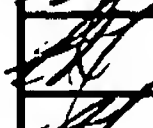
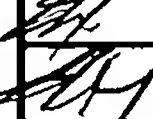


F. TOLEDO

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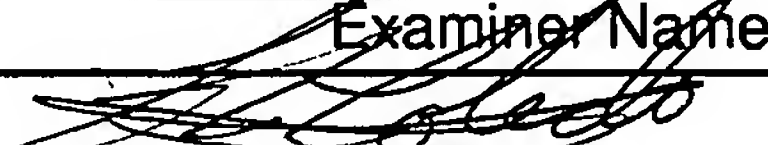
(3752685 or 5337475 or 5614043 or 6143421 or 6329065 or 6346317 or 6426126
) .pn

US Patent Documents

Note: Applicant is not required to submit a paper copy of cited US Patent Documents

init	Cite.No.	Patent No.	Date	Patentee	Kind	Class	Subclass
	1	3752685	1973-08-14	Hidemasa Honda, et al.	1	1	
	2	5337475	1994-08-16	Aoude, et al.			
	3	5614043	1997-03-25	Ritland, et al.			
	4	6143421	2000-11-07	Ritland, et al.			
	5	6329065	2001-12-11	Ishida, et al.			
	6	6346317	2002-02-12	Ritland, et al.			
	7	6426126	2002-07-30	Conover, et al.			

Signature

Examiner Name	Date
	7/8/05



10/707,693

2823

EXAMINER: Initial if citation considered, whether or not citation is in conformance with MPEP Section 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.